

3.0x2.0mm SURFACE MOUNT LED LAMP

AA3020SURCK

HYPER RED

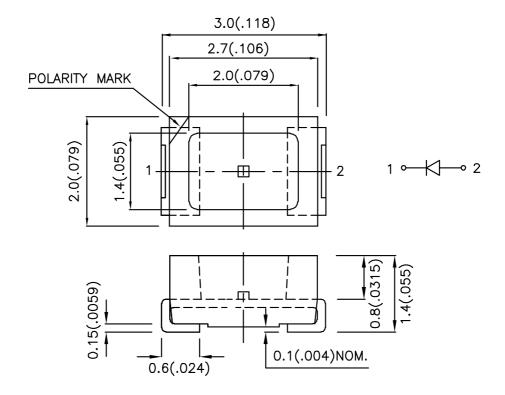
Features

- 3.0MM X 2.0MM, 1.4MM HIGH, ONLY MINIMUM SPACE REQUIRED.
- SUITABLE FOR COMPACT OPTOELECTRONIC APPLICATIONS.
- LOW POWER CONSUMPTION.
- PACKAGE: 2000PCS/REEL.
- RoHS COMPLIANT.

Description

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted. 3. Specifications are subject to change without notice.

SPEC NO: DSAD1214 APPROVED: J. Lu

REV NO: V.3 CHECKED: Allen Liu DATE: MAR/17/2005 DRAWN: H.Q.YUAN

PAGE: 1 OF 4 ERP:1201000146

Kingbright

Selection Guide

Part No.	Dice	Iv (mcd) Dice Lens Type @ 20mA		,	Viewing Angle
			Min.	Тур.	201/2
AA3020SURCK	HYPER RED (InGaAIP)	WATER CLEAR	70	200	90°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	635		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
I R	Reverse Current	Hyper Red		10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

Parameter	Hyper Red	Units
Power dissipation	170	mW
DC Forward Current	30	mA
Peak Forward Current [1]	185	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

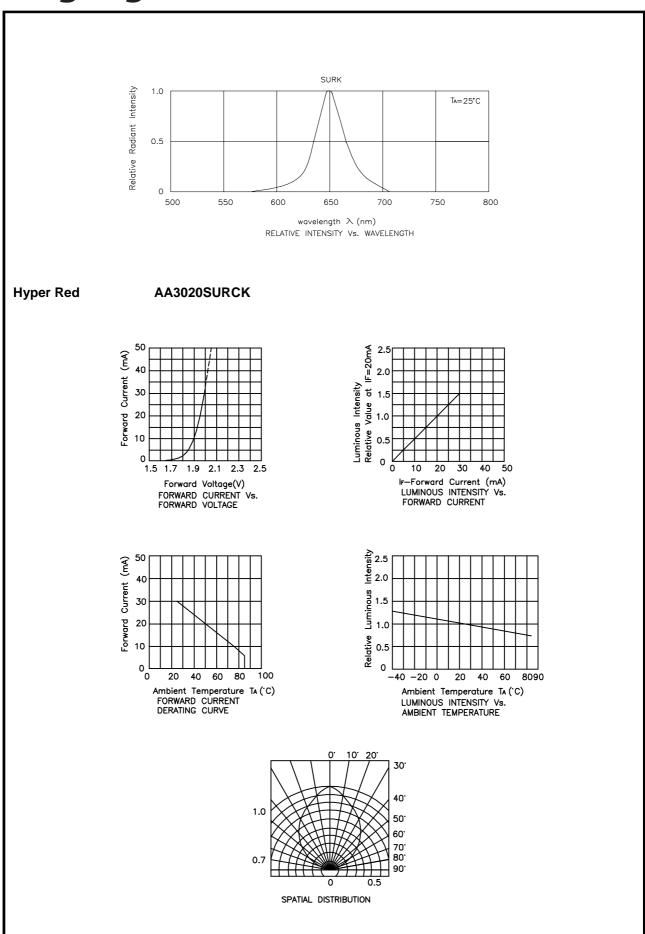
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAD1214 APPROVED: J. Lu REV NO: V.3 CHECKED: Allen Liu DATE: MAR/17/2005 DRAWN: H.Q.YUAN PAGE: 2 OF 4 ERP:1201000146

 $^{1.\,\}theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Kingbright

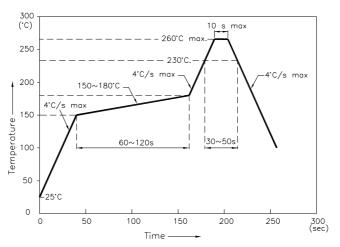


SPEC NO: DSAD1214 APPROVED: J. Lu REV NO: V.3 CHECKED: Allen Liu DATE: MAR/17/2005 DRAWN: H.Q.YUAN PAGE: 3 OF 4 ERP:1201000146

Kingbright

AA3020SURCK

Reflow Soldering Profile For Lead-free SMT Process.

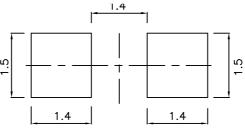


NOTES:

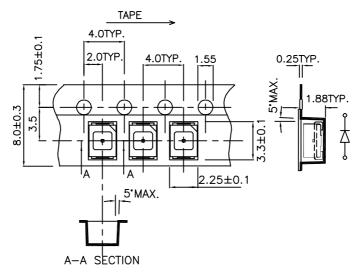
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern

(Units: mm)



Tape Specifications (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

 SPEC NO: DSAD1214
 REV NO: V.3
 DATE: MAR/17/2005
 PAGE: 4 OF 4

 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: H.Q.YUAN
 ERP:1201000146